

### **CPU Supervisor with 8Kbit SPI EEPROM**

### **FEATURES**

- Low V<sub>CC</sub> detection and reset assertion **—Four standard reset threshold voltages 4.63V, 4.38V, 2.93V, 2.63V**
	- **-Re-program low V<sub>CC</sub> reset threshold voltage using special programming sequence.**  $-$ Reset signal valid to  $V_{CC}$  = 1V
- **Selectable time out watchdog timer**
- **Long battery life with low power consumption —<50µA max standby current, watchdog on —<1µA max standby current, watchdog off —<400µA max active current during read**
- **8Kbits of EEPROM**
- **Save critical data with Block Lock™ memory —Block lock first or last page, any 1/4 or lower 1/2 of EEPROM array**
- **Built-in inadvertent write protection —Write enable latch —Write protect pin**
- **SPI Interface 3.3MHz clock rate**
- **Minimize programming time**
	- **—16 byte page write mode —5ms write cycle time (typical)**
- **SPI modes (0,0 & 1,1)**
- **Available packages**
	- **—8-lead TSSOP, 8-lead SOIC, 8-Lead PDIP**

### **APPLICATIONS**

- **Communications Equipment —Routers, Hubs, Switches —Set Top Boxes**
- **Industrial Systems —Process Control**
	- **—Intelligent Instrumentation**
- **Computer Systems —Desktop Computers —Network Servers**
- **Battery Powered Equipment**





# Timebase **X5083**



See "Ordering Information" on page 21 for more details

For Custom Settings, call Xicor.

### **DESCRIPTION**

This device combines four popular functions, Power-on Reset Control, Watchdog Timer, Supply Voltage Supervision, and Block Lock Serial EEPROM Memory in one package. This combination lowers system cost, reduces board space requirements, and increases reliability.

Applying power to the device activates the power on reset circuit which holds RESET active for a period of time. This allows the power supply and oscillator to stabilize before the processor can execute code.

The Watchdog Timer provides an independent protection mechanism for microcontrollers. When the microcontroller fails to restart a timer within a selectable time out interval, the device activates the RESET signal. The user selects the interval from three preset values. Once selected, the interval does not change, even after cycling the power.

The device's low  $V_{CC}$  detection circuitry protects the user's system from low voltage conditions, resetting the system when  $V_{CC}$  falls below the minimum  $V_{CC}$  trip point. RESET is asserted until  $V_{CC}$  returns to the proper operating level and stabilizes. Five industry standard  $V_{TRIP}$  thresholds are available, however, Xicor's unique circuits allow the threshold to be reprogrammed to meet custom requirements or to fine-tune the threshold for applications requiring higher precision.

### **PIN CONFIGURATION**



### **PIN DESCRIPTION**



### **PRINCIPLES OF OPERATION**

### **Power On Reset**

Application of power to the X5083 activates a power on reset circuit. This circuit goes LOW at 1V and pulls the RESET pin active. This signal prevents the system microprocessor from starting to operate with insufficient voltage or prior to stabilization of the oscillator. RESET active also blocks communication to the device through the SPI interface. When  $V_{CC}$  exceeds the device  $V_{TRIP}$  value for 200ms (nominal) the circuit releases RESET, allowing the processor to begin executing code. While  $V_{CC}$  <  $V_{TRIP}$  communications to the device are inhibited.

### **Low Voltage Monitoring**

During operation, the X5083 monitors the  $V_{CC}$  level and asserts RESET if supply voltage falls below a preset minimum  $V_{TRIP}$  The RESET signal prevents the microprocessor from operating in a power fail or brownout condition and terminates any SPI communication in progress. The RESET signal remains active until the voltage drops below 1V. It also remains active until  $V_{CC}$  returns and exceeds  $V_{TRIP}$  for 200ms.

When  $V_{CC}$  falls below  $V_{TR}$  any communications in progress are terminated and communications are inhibited until  $V_{CC}$  exceeds  $V_{TRIP}$  for t<sub>PURST</sub>.

### **Watchdog Timer**

The watchdog timer circuit monitors the microprocessor activity by monitoring the WDI input. The microprocessor must toggle the CS/WDI pin periodically to prevent a RESET signal. The CS/WDI pin must be toggled from HIGH to LOW prior to the expiration of the watchdog time out period. The state of two nonvolatile control bits in the status register determine the watchdog timer period. The microprocessor can change these watchdog bits with no action taken by the microprocessor these bits remain unchanged, even after total power failure.

### **V<sub>CC</sub> Threshold Reset Procedure**

The X5083 is shipped with a standard  $V_{CC}$  threshold  $(V_{TRIP})$  voltage. This value will not change over normal operating and storage conditions. However, in applications where the standard  $V_{TRIP}$  is not exactly right, or if higher precision is needed in the  $V_{TRIP}$  value, the X5083 threshold may be adjusted. The procedure is described below, and uses the application of a high voltage control signal.

### **Setting the V<sub>TRIP</sub> Voltage**

This procedure is used to set the  $V_{TRIP}$  to a higher voltage value. For example, if the current  $V_{TRIP}$  is 4.4V and the new  $V_{TRIP}$  is 4.6V, this procedure will directly make the change. If the new setting is to be lower than the current setting, then it is necessary to reset the trip point before setting the new value.

To set the new  $V_{TRIP}$  voltage, apply the desired  $V_{TRIP}$ threshold voltage to the  $V_{CC}$  pin and tie the  $\overline{WP}$  pin to the programming voltage  $V_{\mathsf{P}}$  Then send a WREN command, followed by a write of Data 00h to address 01h. CS going HIGH on the write operation initiates the  $V_{TRIP}$  programming sequence. Bring  $\overline{WP}$  LOW to complete the operation.

**Note:** This operation also writes 00h to array address 01h.





### **Resetting the V<sub>TRIP</sub> Voltage**

This procedure is used to set the  $V_{TRIP}$  to a "native" voltage level. For example, if the current  $V_{TRIP}$  is 4.4V and the new  $V_{TRIP}$  must be 4.0V, then the  $V_{TRIP}$  must be reset. When  $V_{TRIP}$  is reset, the new  $V_{TRIP}$  is something less than 1.7V. This procedure must be used to set the voltage to a lower value.

To reset the new  $V_{TRIP}$  voltage, apply the desired  $V_{TRIP}$  threshold voltage to the Vcc pin and tie the  $\overline{WP}$ pin to the programming voltage  $V_{\mathsf{P}}$  Then send a WREN command, followed by a write of data 00h to address 03h. CS going HIGH on the write operation initiates the  $V_{TRIP}$  programming sequence. Bring  $\overline{WP}$  LOW to complete the operation.

**Note:** This operation also writes 00h to array address 03h.



Figure 2. Reset V<sub>TRIP</sub> Level Sequence (V<sub>CC</sub> > 3V.  $\overline{WP}$  = 15-18V)

**Figure 3. Sample V<sub>TRIP</sub> Reset Circuit** 







### **SPI Serial Memory**

The memory portion of the device is a CMOS serial EEPROM array with Xicor's block lock protection. The array is internally organized as x 8. The device features a Serial Peripheral Interface (SPI) and software protocol allowing operation on a simple four-wire bus.

The device utilizes Xicor's proprietary Direct Write™ cell, providing a minimum endurance of 100,000 cycles and a minimum data retention of 100 years.

The device is designed to interface directly with the synchronous Serial Peripheral Interface (SPI) of many popular microcontroller families.

The device monitors the bus and asserts RESET output if the watchdog timer is enabled and there is no bus activity within the user selectable time out period or the supply voltage falls below a preset minimum  $V_{TRIP}$ 

The device contains an 8-bit instruction register. It is accessed via the SI input, with data being clocked in on the rising edge of SCK. CS must be LOW during the entire operation.

All instructions (Table 1), addresses and data are transferred MSB first. Data input on the SI line is latched on the first rising edge of SCK after  $\overline{CS}$  goes LOW. Data is output on the SO line by the falling edge of SCK. SCK is static, allowing the user to stop the clock and then start it again to resume operations where left off.

### **Write Enable Latch**

The device contains a Write Enable Latch. This latch must be SET before a Write Operation is initiated. The WREN instruction will set the latch and the WRDI instruction will reset the latch (Figure 7). This latch is automatically reset upon a power-up condition and after the completion of a valid Write Cycle.

### **Status Register**

The RDSR instruction provides access to the status register. The status register may be read at any time, even during a write cycle. The status register is formatted as follows.

### **Status Register/Block Lock/WDT Byte**



### **Block Lock Memory**

Xicor's block lock memory provides a flexible mechanism to store and lock system ID and parametric information. There are seven distinct block lock memory areas within the array which vary in size from one page to as much as half of the entire array. These areas and associated address ranges are block locked by writing the appropriate two byte block lock instruction to the device as described in Table 1 and Figure 9. Once a block lock instruction has been completed, that block lock setup is held in the nonvolatile status register until the next block lock instruction is issued. The sections of the memory array that are block locked can be read but not written until block lock is removed or changed.

### **Table 1. Instruction Set and Block Lock Protection Byte Definition**



### **Watchdog Timer**

The watchdog timer bits, WD0 and WD1, select the watchdog time out period. These nonvolatile bits are programmed with the WRSR instruction. A change to the Watchdog Timer, either setting a new time out period or turning it off or on, takes effect, following either the next command (read or write) or cycling the power to the device.

The recommended procedure for changing the Watchdog Timer settings is to do a WREN, followed by a write status register command. Then execute a software loop to read the status register until the MSB of the status byte is zero. A valid alternative is to do a WREN, followed by a write status register command. Then wait 10ms and do a read status command.

### **Table 2. Watchdog Timer Definition**



### **Read Sequence**

When reading from the EEPROM memory array,  $\overline{CS}$  is first pulled low to select the device. The 8-bit READ instruction is transmitted to the device, followed by the 16-bit address. After the READ opcode and address are sent, the data stored in the memory at the selected address is shifted out on the SO line. The data stored in memory at the next address can be read sequentially by continuing to provide clock pulses. The address is automatically incremented to the next higher address after each byte of data is shifted out. When the highest address is reached, the address counter rolls over to address \$0000 allowing the read cycle to be continued indefinitely. The read operation is terminated by taking  $\overline{CS}$  high. Refer to the read EEPROM array sequence (Figure 5).

To read the status register, the  $\overline{CS}$  line is first pulled low to select the device followed by the 8-bit RDSR instruction. After the RDSR opcode is sent, the contents of the status register are shifted out on the SO line. Refer to the read status register sequence (Figure 6).

### **Write Sequence**

Prior to any attempt to write data into the device, the "Write Enable" Latch (WEL) must first be set by issuing the WREN instruction (Figure 7). CS is first taken LOW, then the WREN instruction is clocked into the device. After all eight bits of the instruction are transmitted,  $\overline{\text{CS}}$ must then be taken HIGH. If the user continues the write operation without taking  $\overline{CS}$  HIGH after issuing the WREN instruction, the write operation will be ignored.

To write data to the EEPROM memory array, the user then issues the WRITE instruction followed by the 16 bit address and then the data to be written. Any unused address bits are specified to be "0's". The WRITE operation minimally takes 32 clocks.  $\overline{\text{CS}}$  must go low and remain low for the duration of the operation. If the address counter reaches the end of a page and the clock continues, the counter will roll back to the first address of the same page and overwrite any data that may have been previously written.

For a write operation (byte or page write) to be completed, CS can only be brought HIGH after bit 0 of the last data byte to be written is clocked in. If it is brought HIGH at any other time, the write operation will not be completed (Figure 8).

To write to the status register, the WRSR instruction is followed by the data to be written (Figure 9). Data bits 5, 6 and 7 must be "0".

### **Read Status Operation**

If there is not a nonvolatile write in progress, the read status instruction returns the block lock setting from the status register which contains the watchdog timer bits WD1, WD0, and the block lock bits IDL2-IDL0 (Figure 6). The block lock bits define the block lock condition (Table 1). The watchdog timer bits set the operation of the watchdog timer (Table 2). The other bits are reserved and will return '0' when read. See Figure 6.

During an internal nonvolatile write operaiton, the Read Status Instruction returns a HIGH on SO in the first bit following the RDSR instruction (the MSB). The remaining bits in the output status byte are undefined. Repeated Read Status Instructions return the MSB as a '1' until the nonvolatile write cycle is complete. When the nonvolatile write cycle is completed, the RDSR instruction returns a '0' in the MSB position with the remaining bits of the status register undefined. Subsequent RDSR instructions return the Status Register Contents. See Figure 10.

### **RESET Operation**

The RESET output is designed to go LOW whenever  $V_{\rm CC}$  has dropped below the minimum trip point and/or the watchdog timer has reached its programmable time out limit.

The RESET output is an open drain output and requires a pull up resistor.

### **Operational Notes**

The device powers-up in the following state:

- The device is in the low power standby state.
- A HIGH to LOW transition on  $\overline{CS}$  is required to enter an active state and receive an instruction.
- SO pin is high impedance.
- The write enable latch is reset.
- $-$  Reset signal is active for t<sub>PURST</sub>.

### **Data Protection**

The following circuitry has been included to prevent inadvertent writes:

- A WREN instruction must be issued to set the write enable latch.
- $-\overline{\text{CS}}$  must come HIGH at the proper clock count in order to start a nonvolatile write cycle.
- When  $V_{CC}$  is below  $V_{TRIP}$ , communications to the device are inhibited.

### **Figure 5. Read Operation Sequence**



**Figure 6. Read Status Operation Sequence**











### **Figure 9. Status Register Write Sequence**







**Figure 11. End of Nonvolatile Write (no Polling)**



### **SYMBOL TABLE**



### **ABSOLUTE MAXIMUM RATINGS**



# **COMMENT**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; the functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **RECOMMENDED OPERATING CONDITIONS**





### **D.C. OPERATING CHARACTERISTICS** (Over the recommended operating conditions unless otherwise specified.)



### **POWER-UP TIMING**



### **CAPACITANCE**  $T_A = +25^\circ C$ ,  $f = 1$ MHz,  $V_{CC} = 5V$ .



**Notes:** (1)  $V_{\text{IL}}$  min. and  $V_{\text{IH}}$  max. are for reference only and are not tested. (2) This parameter is periodically sampled and not 100% tested.

### **EQUIVALENT A.C. LOAD CIRCUIT AT 5V V<sub>CC</sub> A.C. TEST CONDITIONS**





**A.C. CHARACTERISTICS** (Over recommended operating conditions, unless otherwise specified)

### **Data Input Timing**



### **Data Output Timing**



**Notes:** (3) This parameter is periodically sampled and not 100% tested.

(4)  $t_{WC}$  is the time from the rising edge of  $\overline{CS}$  after a valid write sequence has been sent to the end of the self-timed internal nonvolatile write cycle.

### **Serial Output Timing**



### **Serial Input Timing**



### **Power-Up and Power-Down Timing**



### **RESET Output Timing**



**Note:** (5) This parameter is periodically sampled and not 100% tested.

(6) PT= Package/Temperature

### **CS vs. RESET Timing**



### **RESET Output Timing**



### **V<sub>TRIP</sub> Programming Timing Diagram**



### **V<sub>TRIP</sub> Programming Parameters**



Note 1: V<sub>TRIP</sub> programming parameters are periodically sampled and are not 100% tested.

2: For custom  $V_{TRIP}$  settings, Contact Factory.

### **PACKAGING INFORMATION**





**NOTE: 1. ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS) 2. PACKAGE DIMENSIONS EXCLUDE MOLDING FLASH**

### **PACKAGING INFORMATION**

**8-Lead Plastic Small Outline Gull Wing Package Type S**



**NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)** 

### **PACKAGING INFORMATION**



### **8-Lead Plastic, TSSOP, Package Type V**

**NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)**

### **Ordering Information**



### **Part Mark Convention**

#### **8-Lead TSSOP**



583F = 2.7 to 5.5V, 0 to +70°C,  $V_{TRIP}$  = 2.55-2.7V  $583G = 2.7$  to 5.5V, -40 to +85°C,  $V_{TRIP} = 2.55 - 2.7V$  $X583 = 4.5$  to 5.5V, 0 to +70°C, V<sub>TRIP</sub> = 4.25-4.5V 583I = 4.5 to 5.5V, -40 to +85°C, V<sub>TRIP</sub> = 4.25-4.5V 583AN = 2.7 to 5.5V, 0 to +70°C,  $V_{TRIP}$  = 2.85-3.0V 583AP = 2.7 to 5.5V, -40 to +85°C,  $V_{TRIP} = 2.85 - 3.0V$ 583AL = 4.5 to 5.5V, 0 to +70°C, V<sub>TRIP</sub> = 4.5-4.75V 583AM = 4.5 to 5.5V, -40 to +85°C,  $V_{TRIP}$  = 4.5-4.75V

YWW = year/work week device is packaged.

### **8-Lead SOIC/PDIP**



F = 2.7 to 5.5V, 0 to +70°C,  $V_{TRIP}$  = 2.55-2.7V  $G = 2.7$  to 5.5V, -40 to +85°C,  $V_{TRIP} = 2.55$ -2.7V Blank = 4.5 to 5.5V, 0 to +70°C,  $V_{TRIP} = 4.25 - 4.5V$  $I = 4.5$  to 5.5V, -40 to +85°C,  $V_{TRIP} = 4.25$ -4.5V AN = 2.7 to 5.5V, 0 to +70°C,  $\rm V_{TRIP}$  = 2.85-3.0V  $AP = 2.7$  to 5.5V, -40 to +85°C, V<sub>TRIP</sub> = 2.85-3.0V AL = 4.5 to 5.5V, 0 to +70°C,  $V_{TRIP}$  = 4.5-4.75V AM = 4.5 to 5.5V, -40 to +85°C,  $V_{TRIP}$  = 4.5-4.75V

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Xicor products are covered by one or more of the following U.S. Patents: 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829,482; 4,874,967; 4,883,976; 4,980,859; 5,012,132; 5,003,197; 5,023,694; 5,084,667; 5,153,880; 5,153,691; 5,161,137; 5,219,774; 5,270,927; 5,324,676; 5,434,396; 5,544,103; 5,587,573; 5,835,409; 5,977,585. Foreign patents and additional patents pending.

#### **LIFE RELATED POLICY**

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.